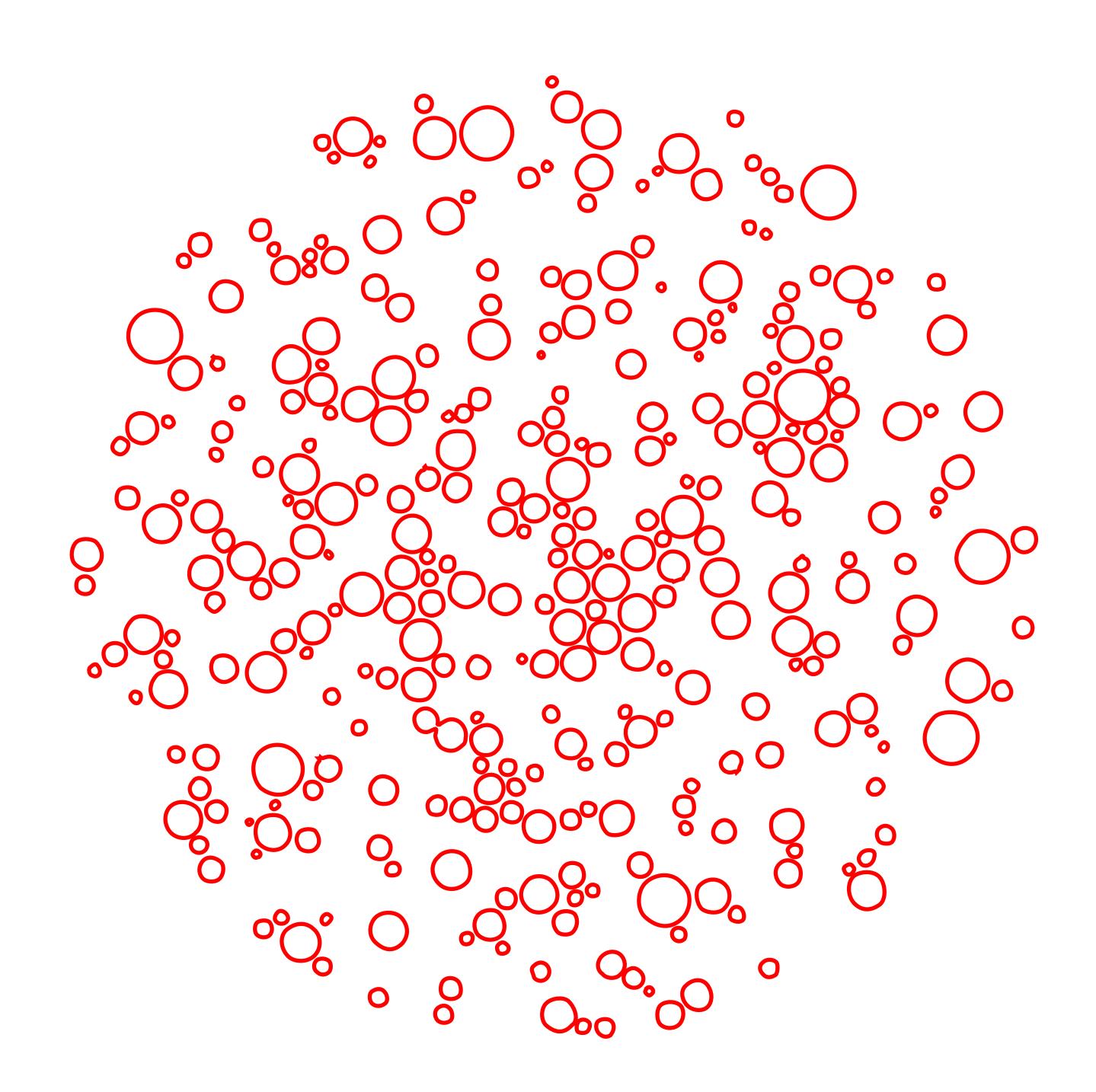
# CUTTING PASS # 1 PLACE BASEOAORNMTUESABEO.ORNMHE LASER CUTTER PLACE A SHEET OF 0.03MM CELLOPHANE IN THE LASER CUTTER

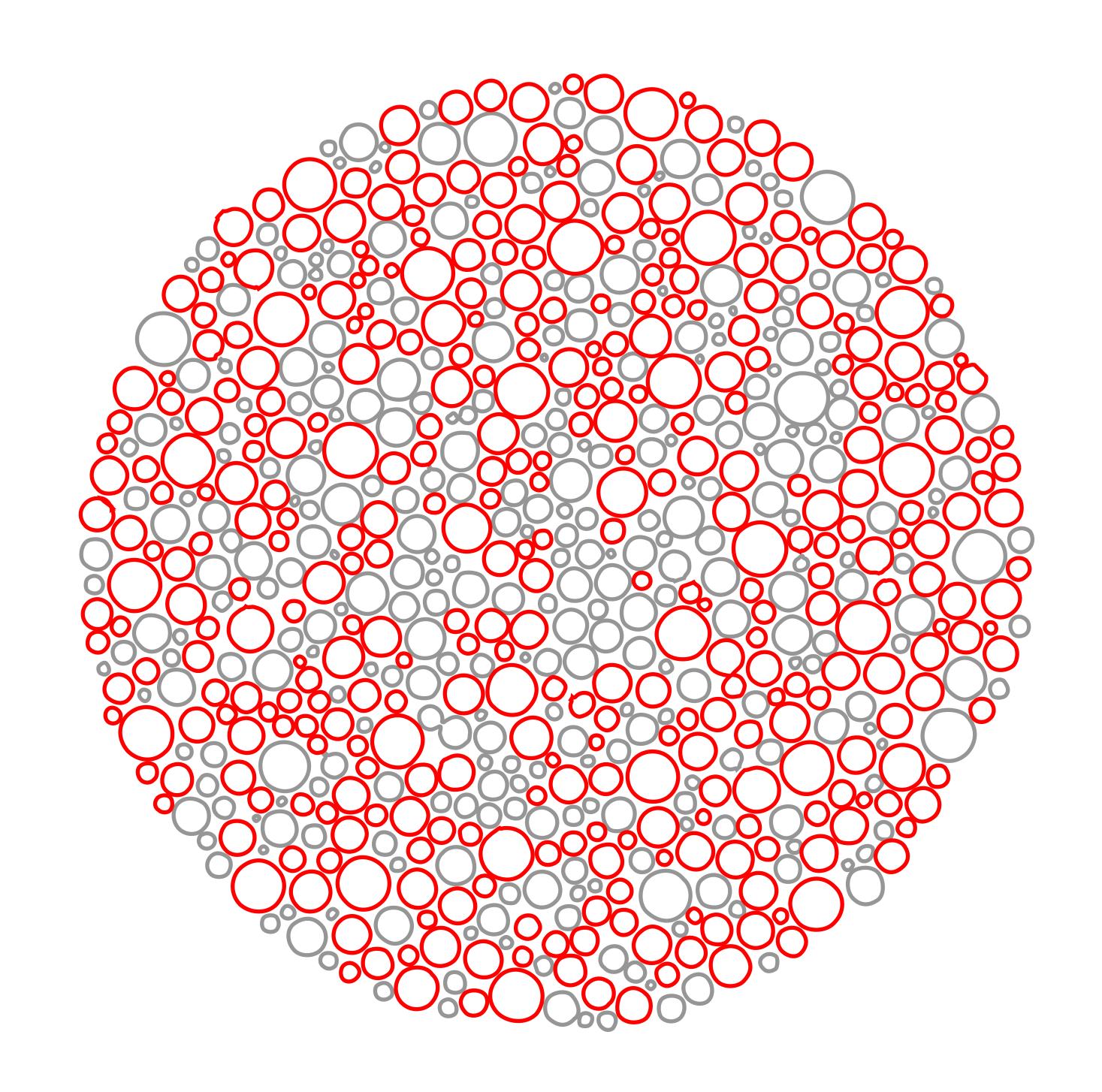


POWER: 12.5%

SPEED: 3%

LASER Z: 0.03 MM

# CUTTING PASS # 2 PLACE BASE AND MAN CELLOPHANE IN THE LASER CUTTER PLACE A SHEET OF 0.045MM CELLOPHANE IN THE LASER CUTTER

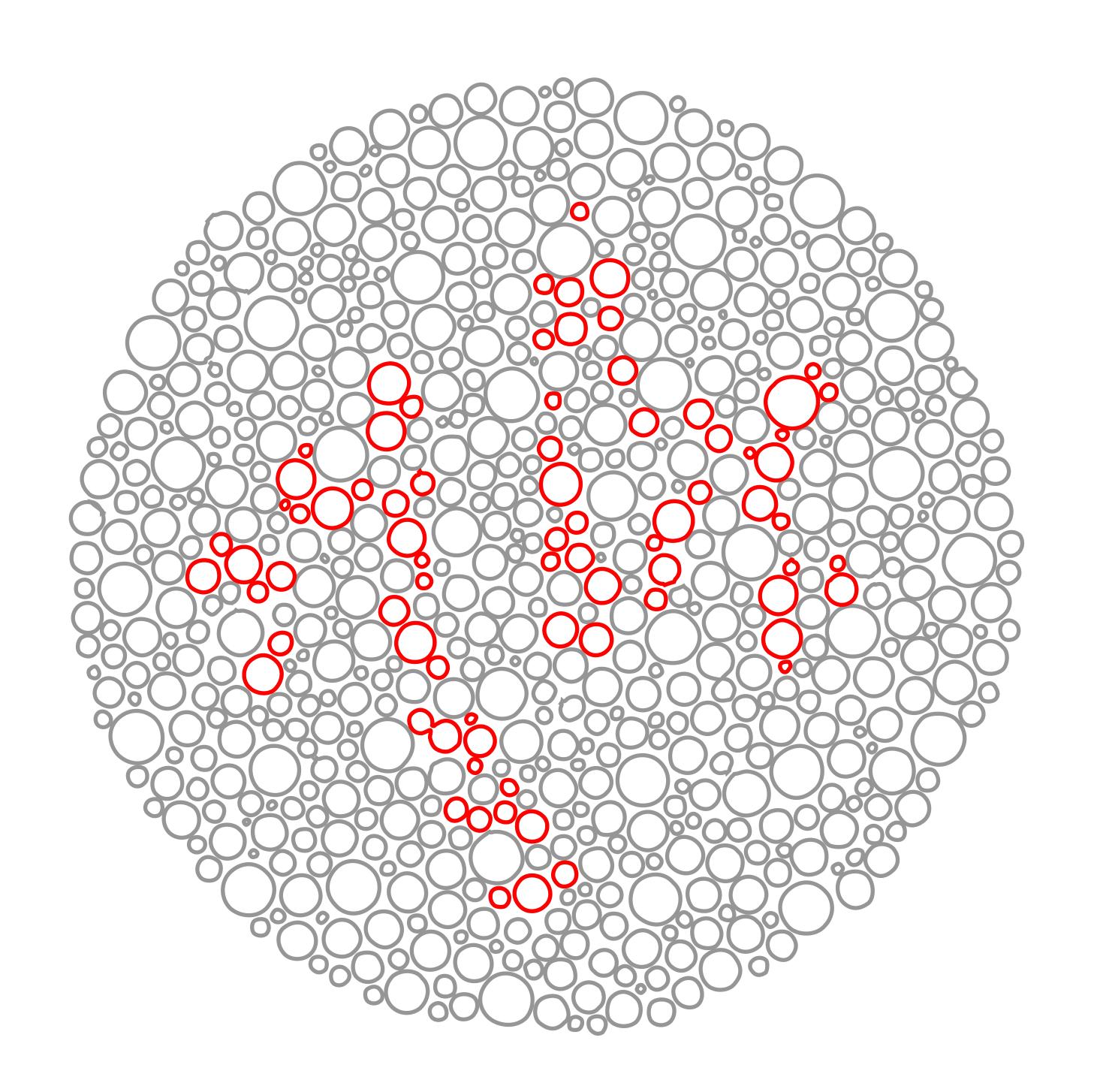


POWER: 12.5%

SPEED: 3%

LASER Z: 0.045 MM

# CUTTING PASS # 3 PLACE BASEOAORMMITHESALEO.OAMMHE LASER CUTTER PLACE A SHEET OF 0.03MM CELLOPHANE IN THE LASER CUTTER



POWER: 12.5%

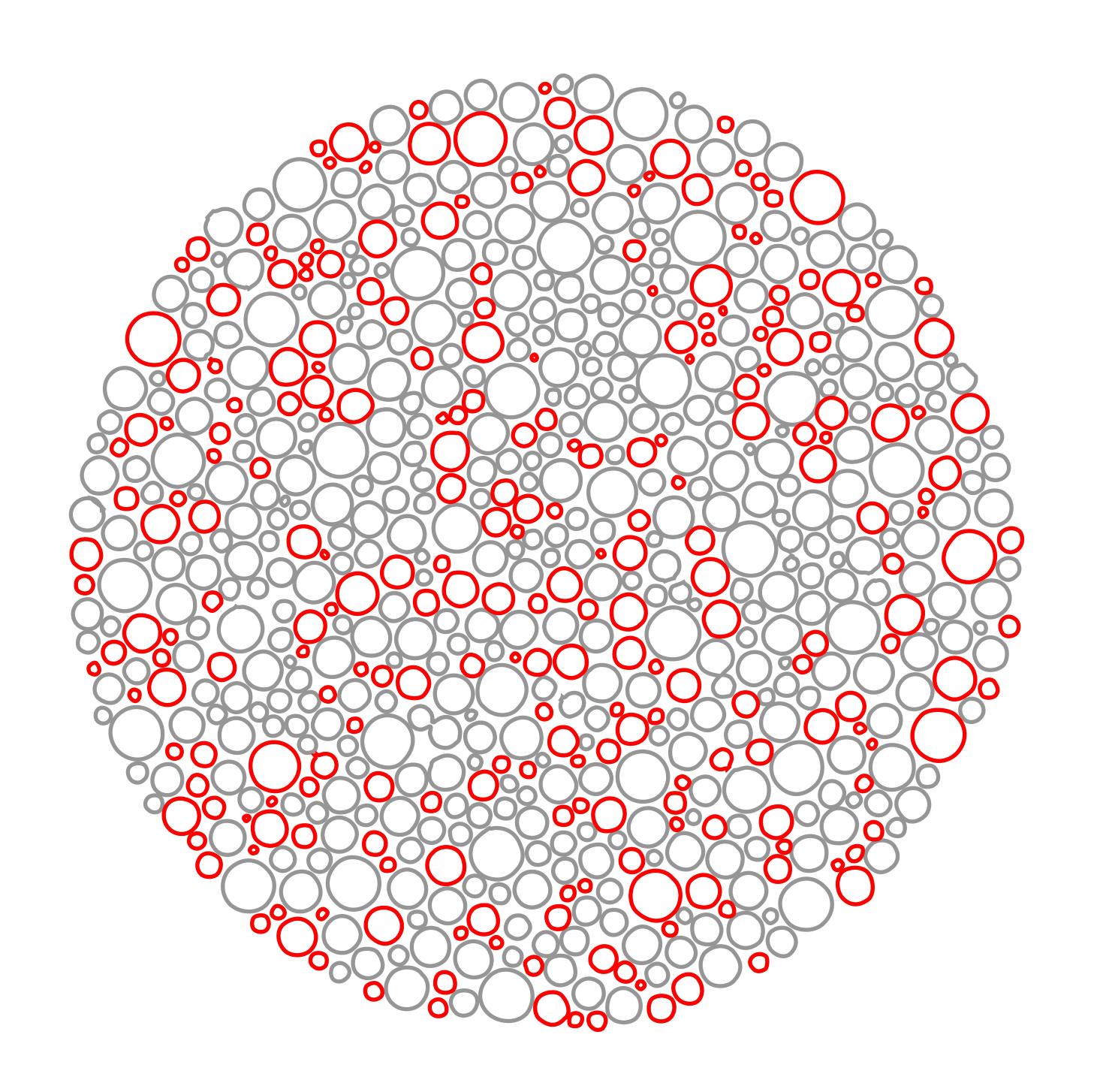
SPEED: 3%

LASER Z: 0.06 MM

CUTTING PASS # 4

PLACE BASE ACAPMENT CELLOPHANE IN THE LASER CUTTER

PLACE A SHEET OF 0.045MM CELLOPHANE IN THE LASER CUTTER



POWER: 12.5%

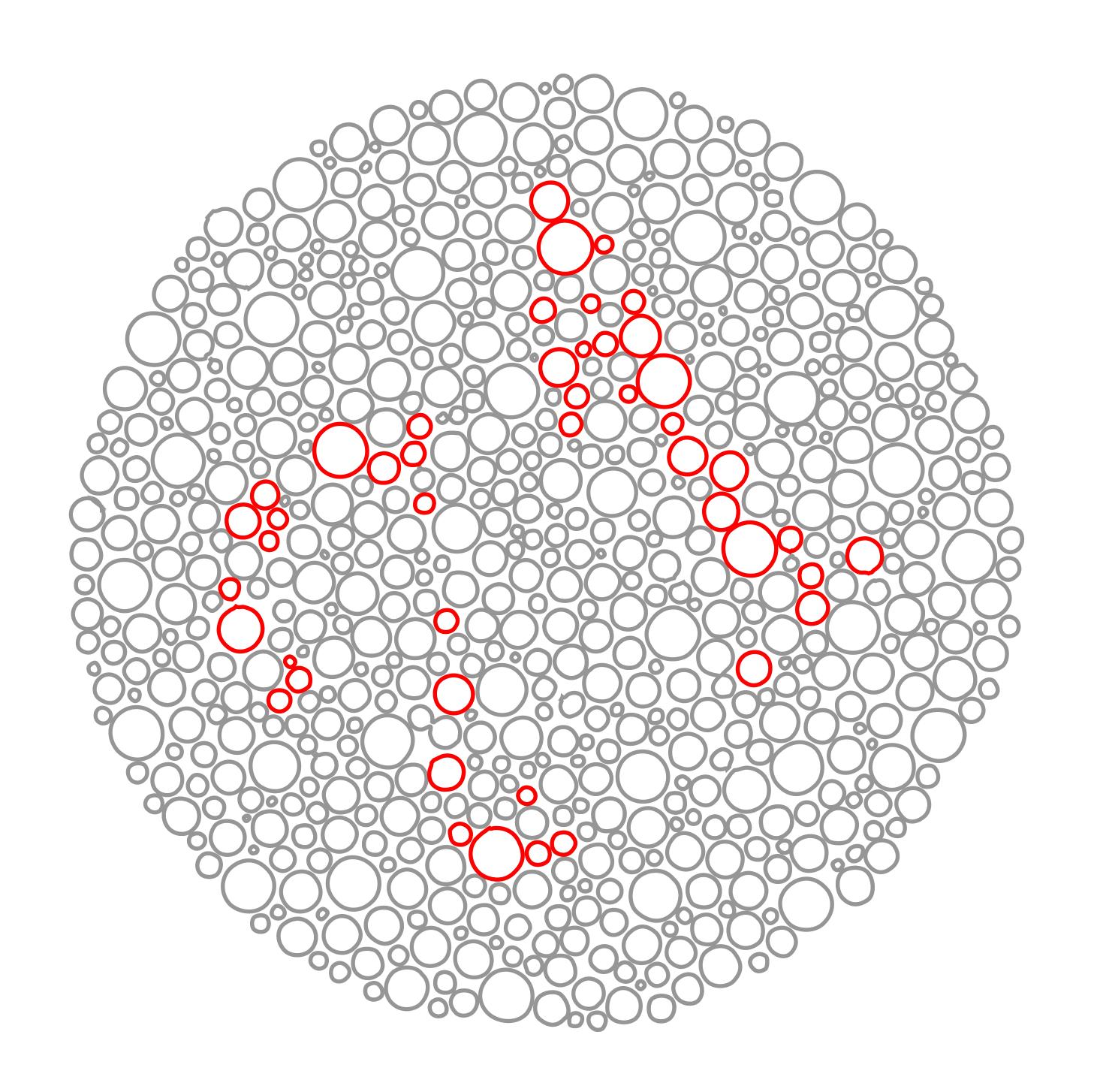
SPEED: 3%

LASER Z: 0.075 MM

CUTTING PASS # 5

PLACE BASEO ACASMM CHEHETO IN THE LASER CUTTER

PLACE A SHEET OF 0.045MM CELLOPHANE IN THE LASER CUTTER

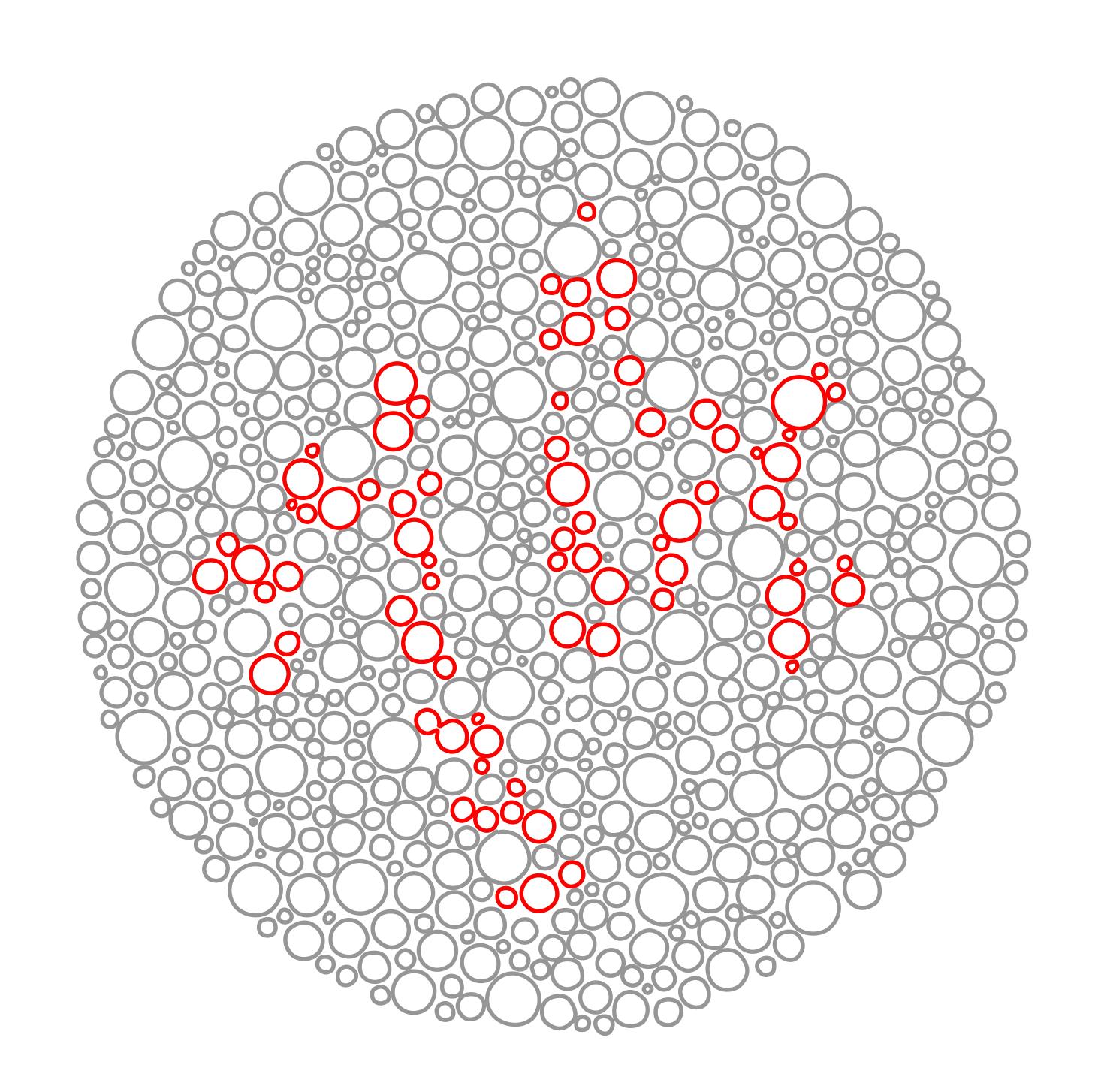


POWER: 12.5%

SPEED: 3%

LASER Z: 0.09 MM

# CUTTING PASS # 6 PLACE BASE ARCAMMINETER FLACE A SHEET OF 0.045MM CELLOPHANE IN THE LASER CUTTER

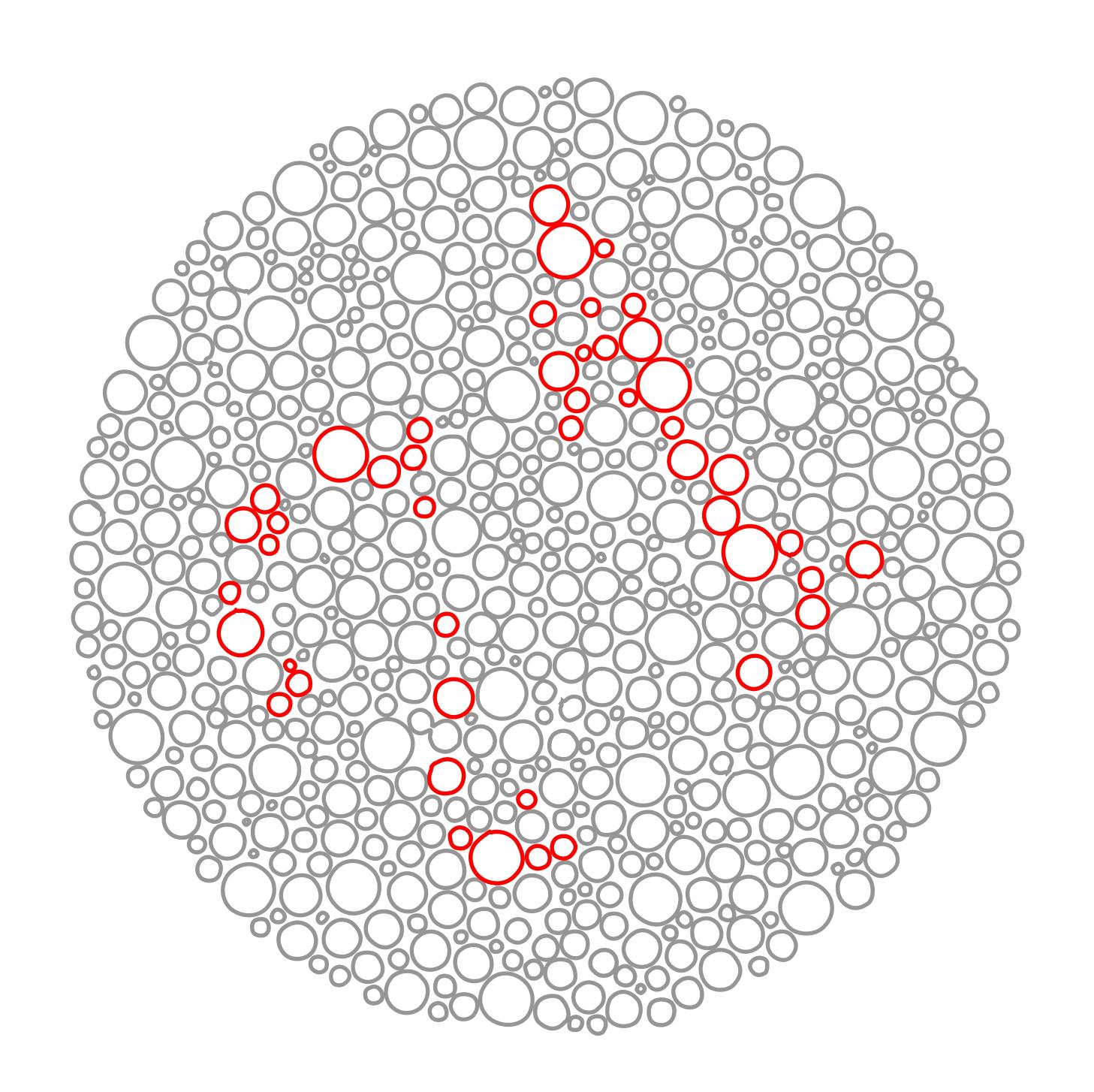


POWER: 12.5%

SPEED: 3%

LASER Z: 0.105 MM

# CUTTING PASS # 7 PLACE BASE ARCHAMMENTE SHEET OF 0.045MM CELLOPHANE IN THE LASER CUTTER



POWER: 12.5%

SPEED: 3%

LASER Z: 0.135 MM